

## **PNP Silicon Low Power Transistor**

Rev. V3

### **Features**

- Available in JAN, JANTX, JANTXV per MIL-PRF-19500/350
- TO-5 Package: 2N3867, 2N3868
- TO-39 Package: 2N3867S, 2N3868S
- Designed for High Speed Switching and Amplifier Applications



# Electrical Characteristics (T<sub>A</sub> = 25°C unless otherwise noted)

| Parameter                              | Test Conditions   | Symbol  | Units | Min.                             | Max.                  |
|--|---|---|-------|----------------------------------|-----------------------|
|  |   |   |       |                                  |                       |
| Collector - Base Breakdown Voltage     | $V_{CB}$ = -40V 2N3867, 2N3867S $V_{CB}$ = -60V 2N3868, 2N3868S   | I <sub>CBO1</sub>   | μA dc |                                  | -100                  |
| Collector - Emitter Breakdown Voltage  | $I_C$ = -20 mA dc, 2N3867, 2N3867S $I_C$ = -20 mA dc, 2N3868, 2N3868S   | V <sub>(BR)CEO</sub>  | V dc  | -40<br>-60                       | _                     |
| Collector - Emitter Cutoff Current     | $V_{EB}$ = +2.0 V dc, $V_{CE}$ = -40 Vdc,<br>2N3867, 2N3867S<br>$V_{EB}$ = +2.0 V dc, $V_{CE}$ = -60 Vdc,<br>2N3868, 2N3868S  |   | μA dc | _                                | -1.0<br>-1.0          |
| Emitter - Base Cutoff Current          | V <sub>EB</sub> = -4.0 Vdc  | I <sub>EBO1</sub>   | μA dc | _                                | -100                  |
|  |   |   |       |                                  |                       |
| Forward Current Transfer Ratio         | $V_{\text{CE}} = -1.0 \text{ V dc, } I_{\text{C}} = -500 \text{ mA dc} \\ 2N3867, 2N3867S \\ 2N3868, 2N3868S \\ V_{\text{CE}} = -2.0 \text{ V dc, } I_{\text{C}} = -1.5 \text{ A dc} \\ 2N3867, 2N3867S \\ 2N3868, 2N3868S \\ V_{\text{CE}} = -3.0 \text{ V dc, } I_{\text{C}} = -2.5 \text{ A dc} \\ 2N3867, 2N3867S \\ 2N3867, 2N3867S \\ 2N3868, 2N3868S \\ V_{\text{CE}} = -5.0 \text{ V dc, } I_{\text{C}} = -3.0 \text{ mA dc} \\ \text{All Types}$ | h <sub>FE</sub>   | -     | 50<br>35<br>40<br>30<br>25<br>20 | 200<br>150<br>—       |
| Collector - Emitter Saturation Voltage | $I_C$ = -500 mA dc, $I_B$ = -50 mA dc<br>$I_C$ = -1.5 A dc, $I_B$ = -150 mA dc<br>$I_C$ = -2.5 A dc, $I_B$ = -250 mA dc   | V <sub>CE(sat)1</sub><br>V <sub>CE(sat)2</sub><br>V <sub>CE(sat)3</sub> | V dc  | _                                | -0.5<br>-0.75<br>-1.5 |
| Base - Emitter Saturation Voltage      | $I_C$ = -500 mA dc, $I_B$ = -50 mA dc<br>$I_C$ = -1.5 A dc, $I_B$ = -150 mA dc<br>$I_C$ = -2.5 A, $I_B$ = -250 mA dc  | V <sub>BE(sat)1</sub><br>V <sub>BE(sat)2</sub><br>V <sub>BE(sat)3</sub> | V dc  | -0.9                             | -1.0<br>-1.4<br>-2.0  |

(Continued next page)



# **PNP Silicon Low Power Transistor**

Rev. V3

# Electrical Characteristics (T<sub>A</sub> = +25°C unless otherwise noted)

| Parameter   | Test Conditions  | Symbol            | Units | Min.     | Max.       |
|---|--|-------------------|-------|----------|------------|
|   |  | _                 |       |          |            |
| Collector - Emitter Cutoff Current  | $T_A = +150^{\circ}\text{C}$<br>$V_{EB} = +2.0 \text{ V dc}, V_{CE} = -40 \text{ Vdc},$<br>2N3867, 2N3867S<br>$V_{EB} = +2.0 \text{ V dc}, V_{CE} = -60 \text{ Vdc},$<br>$2\text{N}3868, 2\text{N}3868\text{S}}$ | I <sub>CEX2</sub> | μA dc | _        | -50<br>-50 |
| Forward-Current Transfer Ratio  | $T_A = -55^{\circ}C$<br>$V_{CE} = -1.0 \text{ V dc, } I_C = -500 \text{ mA dc}$<br>2N3867, 2N3867S<br>2N3868, 2N3868S  |                   | V dc  | 25<br>17 |            |
| Dynamic Characteristics   |  |                   |       |          |            |
| Magnitude of Common Emitter Small-Signal Short-Circuit Forward Current Transfer Ratio | $V_{CE}$ = -5.0 V dc, $I_{C}$ = -100 mA dc,<br>f = 20 MHz  | h <sub>fe</sub>   | -     | 3        | 12         |
| Open Circuit Output Capacitance   | V <sub>CB</sub> = 10 Vdc, I <sub>E</sub> = 0, 100 kHz ≤ f ≤ 1 MHz  | C <sub>obo</sub>  | pF    | _        | 120        |
| Input Capacitance   | V <sub>CB</sub> = -3 Vdc, I <sub>C</sub> = 0, 100 kHz ≤ f ≤ 1 MHz  | C <sub>ibo</sub>  | pF    | _        | 800        |
| Switching Characteristics   |  |                   |       |          |            |
| Delay Time  | $V_{CC}$ = -30 V dc, $V_{EB}$ = 0, $I_{C}$ = -1.5 A dc, $I_{B1}$ = -150 mA dc  | t <sub>d</sub>    | ns    | _        | 35         |
| Rise Time   | $V_{CC}$ = -30 V dc, $V_{EB}$ = 0 V dc, $I_{C}$ = -1.5 A dc, $I_{B1}$ = -150 mA dc   | t <sub>r</sub>    | ns    | _        | 65         |
| Storage Time  | $V_{CC}$ = -30 V dc, $V_{EB}$ = 0 V dc, $I_{C}$ = -1.5 A dc, $I_{B1}$ = $I_{B2}$ = -150 mA dc  | t <sub>s</sub>    | ns    | _        | 500        |
| Fall Time   | $V_{CC}$ = -30 V dc, $V_{EB}$ = 0V dc, $I_{C}$ = -1.5 A dc, $I_{B1}$ = $I_{B2}$ = -150 mA dc   | t <sub>f</sub>    | ns    | _        | 100        |



## **PNP Silicon Low Power Transistor**

Rev. V3

# Absolute Maximum Ratings (T<sub>A</sub> = +25°C unless otherwise noted)

| Ratings  | Symbol                            | Value                |
|--|-----------------------------------|----------------------|
| Collector - Emitter Voltage<br>2N3867, 2N3867S<br>2N3868, 2N3868S                  | V <sub>CEO</sub>                  | -40 V dc<br>-60 V dc |
| Collector - Base Voltage<br>2N3867, 2N3867S<br>2N3868, 2N3868S                     | V <sub>CBO</sub>                  | -40 V dc<br>-60 V dc |
| Emitter - Base Voltage   | $V_{EBO}$                         | -4.0 V dc            |
| Collector Current  | Ic                                | -3.0 A dc            |
| Total Power Dissipation  @ $T_A = +25^{\circ}C^{(1)}$ @ $T_C = +25^{\circ}C^{(2)}$ | P <sub>T</sub>                    | 1.0 W<br>10 W        |
| Operating & Storage Temperature Range  | T <sub>J</sub> , T <sub>STG</sub> | -65°C to +200°C      |

<sup>(1)</sup> For derating, see figures 5, 6, 7 and 8 of MIL-PRF-19500/350.

### **Thermal Characteristics**

| Characteristics                      | Symbol           | Max. Value |
|--------------------------------------|------------------|------------|
| Thermal Resistance, Junction to Case | R <sub>θJC</sub> | 17.5°C/W   |

| Safe Operating Area           |   |
|-------------------------------|---|
| DC Tests:                     | T <sub>C</sub> = +25°C, I Cycle, t = 1.0 s (see figure 15 of MIL-PRF-19500/350  |
| Test 1:<br>Test 2:<br>Test 3: | $V_{CE}$ = -3.33 V dc, $I_{C}$ = -3 A dc<br>$V_{CE}$ = -40 V dc, $I_{C}$ = -160 mA dc, 2N3867, 2N3867S<br>$V_{CE}$ = -60 V dc, $I_{C}$ = -80 mA dc, 2N3868, 2N3868S |

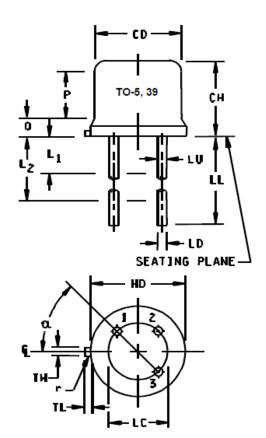
<sup>(2)</sup> For thermal curves, see figures 9, 10, 11 and 12 of MIL-PRF-19500/350.

### **PNP Silicon Low Power Transistor**

Rev. V3

### Outline Drawings (TO-5, TO-39)

| Dimensions           |                    |      |         |      |         |  |   |
|----------------------|--------------------|------|---------|------|---------|--|---|
| Symbol               | Inches Millimeters |      | Note    |      |         |  |   |
|                      | Min                | Max  | Min     | Max  |         |  |   |
| CD                   | .305               | .335 | 7.75    | 8.51 | 5, 6    |  |   |
| CH                   | .240               | .260 | 6.10    | 6.60 |         |  |   |
| HD                   | .335               | .370 | 8.51    | 9.40 | 4, 5    |  |   |
| LC                   | .200 TP            |      | 5.08 TP |      | 5.08 TP |  | 7 |
| LD                   | .016               | .019 | 0.41    | 0.48 | 8,9     |  |   |
| LL                   | See note 8, 14     |      |         |      |         |  |   |
| LU                   | .016               | .019 | 0.41    | 0.48 | 8,9     |  |   |
| L <sub>1</sub>       |                    | .050 |         | 1.27 | 8,9     |  |   |
| L <sub>2</sub>       | .250               |      | 6.35    |      | 8,9     |  |   |
| Р                    | .100               |      | 2.54    |      | 7       |  |   |
| Q                    |                    | .030 |         | 0.76 | 5       |  |   |
| TL                   | .029               | .045 | 0.74    | 1.14 | 3,4     |  |   |
| TW                   | .028               | .034 | 0.71    | 0.86 | 3       |  |   |
| r                    |                    | .010 |         | 0.25 | 10      |  |   |
| α                    | 45°                | TP   | 45° TP  |      | 7       |  |   |
| 1, 2, 10, 12, 13, 14 |                    |      |         |      |         |  |   |



#### NOTES:

- 1. Dimensions are in inches.
- 2. Millimeters are given for general information only.
- 3. Beyond r (radius) maximum, TW shall be held for a minimum length of .011 (0.28 mm).
- 4. Dimension TL measured from maximum HD.
- 5. Body contour optional within zone defined by HD, CD, and Q.
- 6. CD shall not vary more than .010 inch (0.25 mm) in zone P. This zone is controlled for automatic handling.
- Leads at gauge plane .054 +.001 -.000 inch (1.37 +0.03 -0.00 mm) below seating plane shall be within .007 inch (0.18 mm) radius of true position (TP) at maximum material condition (MMC) relative to tab at MMC. The device may be measured by direct methods or by gauging procedure.
- 8. Dimension LU applies between L<sub>1</sub> and L<sub>2</sub>. Dimension LD applies between L<sub>2</sub> and LL minimum. Diameter is uncontrolled in and beyond LL minimum.
- 9. All three leads.
- The collector shall be internally connected to the case.
- Dimension r (radius) applies to both inside corners of tab.
- 12. In accordance with ASME Y14.5M, diameters are equivalent to  $\phi x$  symbology.
- 13. Lead 1 = emitter, lead 2 = base, lead 3 = collector.
- For non-S-suffix devices (TO-5), dimension LL = 1.5 inches (38.10 mm) min. and 1.75 inches (44.45 mm) max. For S-suffix types (TO-39), dimension LL = .5 inch (12.70 mm) min. and .750 inch (19.05 mm) max.

FIGURE 1. Physical dimensions (similar to TO-5, TO-39).



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Rev. V3

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